



# Specification of Automotive MLCC (Reference sheet)

● Supplier : Samsung electro-mechanics

● Product : Multi-layer Ceramic Capacitor

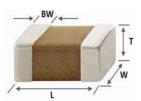
● Samsung P/N: CL05C3R9CC51PNC

● Description : CAP, 3.9pF, 100V, ± 0.25pF, C0G, 0402

● AEC-Q200 Qualified

### A. Dimension

#### Dimension



Size	0402 inch
L	1.00±0.05 mm
W	0.50±0.05 mm
Т	0.50±0.05 mm
BW	0.25±0.10 mm

#### B. Samsung Part Number

<u>CL</u>	<u>05</u>	<u>C</u>	<u>3R9</u>	<u>C</u>	<u>C</u>	<u>5</u>	1	<u>P</u>	<u>N</u>	<u>C</u>
①	2	3	4	(5)	6	<b>⑦</b>	8	9	10	11

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0402 (inch code)	L: 1.00±0.05 mm	W: 0.50±0.05 mm
3 Dielectric	C0G	8 Inner electrode	Ni
4 Capacitance	3.9 pF	Termination	Cu
⑤ Capacitance	± 0.25pF	Plating	Sn 100% (Pb Free)
tolerance		Product	Automotive
Rated Voltage	100 V	Special code	Normal
7 Thickness	0.50±0.05 mm	1 Packaging	Cardboard Type, 7" Reel

#### C. Reliability Test and Judgement condition

	Performance	Test condition			
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1,000hrs @ Max. temperature			
Exposure	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion			
	whichever is larger				
	Q: 478 min.				
	IR : More than 10,000 № or 500 №× µF				
	Whichever is smaller				
Temperature Cycling	Appearance : No abnormal exterior appearance	1,000Cycles			
	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion			
	whichever is larger				
	Q: 478 min.	1 cycle condition : -55+0/-3 °C (30±3min) → Room Temp. (1min)			
	IR : More than 10,000 № or 500 №×μF	→ 125+3/-0°C(30±3min) → Room Temp. (1min)			
	Whichever is smaller				
Destructive Physical	No Defects or abnormalities	Per EIA 469			
Analysis					
Humidity Bias	Appearance : No abnormal exterior appearance	1,000hrs 85 °C/85%RH, Rated Voltage and 1.3~1.5V,			
	Capacitance Change: Within ±2.5% or ±0.25pF	Add 100kohm resistor			
	whichever is larger				
	Q: 112.987 min.	The charge/discharge current is less than 50mA.			
	IR : More than 500 № or 25 №×ДF				
	Whichever is smaller				
High Temperature	Appearance : No abnormal exterior appearance	1,000hrs @ 125 ℃, 200% Rated Voltage,			
Operating Life	Capacitance Change: Within ±3% or ±0.3pF	Measurement at 24±2hrs after test conclusion			
	whichever is larger	The charge/discharge current is less than 50mA.			
	Q: 239 min.				
	IR : More than 1,000 $^{\mathrm{M}\Omega}$ or 50 $^{\mathrm{M}\Omega}\times\mu$ F				
	Whichever is smaller				

	Performance	Test condition			
External Visual	No abnormal exterior appearance	Microscope ('10)			
Physical Dimensions	Within the specified dimensions	Using The calipers			
Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along			
	Capacitance Change: Within ±2.5% or ±0.25pF	3 mutually perpendicular axes of the test specimen (18 shocks)			
	whichever is larger	Peak value   Duration   Wave   Velocity			
		1,500G 0.5ms Half sine 4.7m/sec			
	Q, IR: Initial spec.				
Vibration	Appearance : No abnormal exterior appearance	5g's for 20min., 12cycles each of 3 orientations,			
	Capacitance Change: Within ±2.5% or ±0.25pF	Use 8"×5" PCB 0.031" Thick 7 secure points on one long side			
	whichever is larger	and 2 secure points at corners of opposite sides. Parts mounted			
		within 2" from any secure point. Test from 10~2,000 Hz.			
	Q, IR: Initial spec.				
Resistance to	Appearance : No abnormal exterior appearance	Preheating : 150°C for 60~120 sec.			
Solder Heat	Capacitance Change: Within ±2.5% or ±0.25pF	Solder pot : 260±5 ℃, 10±1sec.			
	whichever is larger				
	Q, IR: Initial spec.				
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002 or ISO/DIS10605			
	Capacitance Change: Within ±2.5% or ±0.25pF				
	whichever is larger				
	Q, IR: Initial spec.	Delicated 455°C for 4 hours to see the for 50 d O45.5°C			
Solderability	95% of the terminations is to be soldered	a) Preheat at 155°C for 4 hours, Immerse in solder for 5s at 245±5°C			
	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5°C			
		c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5 °C solder : a solution ethanol and rosin			
Electrical	Capacitance : Within specified tolerance	The Capacitance / D.F. should be measured at 25°C,			
	Q: 478 min.	1 Mb ± 10%, 0.5~5 Vrms			
Characterization	IR(25℃): More than 100,000 MΩ or 1,000 MΩ×μF	I.R. should be measured with a DC voltage not exceeding			
	Whichever is smaller.	Rated Voltage @25°C, @125°C for 60~120 sec.			
	IR(125℃): More than 10,000 № or 100 №×μF				
	Whichever is smaller.				
	Dielectric Strength	Dielectric Strength: 200% of the rated voltage for 1~5 seconds			
Board Flex	Appearance : No abnormal exterior appearance	Bending to the limit, 3 mm for 60 seconds			
	Capacitance Change: Within ±5% or ±0.5pF				
	whichever is larger				
Terminal	Appearance : No abnormal exterior appearance	2 N, for 60 sec.			
Strength(SMD)	Capacitance Change: Within ±2.5% or ±0.25pF				
	whichever is larger				
Beam Load	Destruction value should be exceed 8 N	Beam speed: 0.5±0.05 mm/sec			
Temperature	COG				
Characteristics	From -55 °C to 125 °C, Capacitance change should	be within 0±30ppm/℃			
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#### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260 +0/-5  $^{\circ}$ C, 30sec. ), Meet IPC/JEDEC J-STD-020 D Standard



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Medical equipment
- 3 Military equipment
- 4 Disaster prevention/crime prevention equipment
- ⑤ Power plant control equipment
- 6 Atomic energy-related equipment
- ① Undersea equipment
- 8 Traffic signal equipment
- Data-processing equipment
- @ Electric heating apparatus, burning equipment
- 19 Safety equipment
- @ Any other applications with the same as or similar complexity or reliability to the applications